



N 沟道增强型场效应晶体管

N-CHANNEL MOSFET

FHP10N65B/FHF10N65B

主要参数 MAIN CHARACTERISTICS

ID	10A
VDSS	650V
Rdson-typ(@Vgs=10V)	0.75Ω
Qg-typ	30nC

产品特性 FEATURES

低栅极电荷	Low gate charge
低 Crss (典型值 18pF)	Low Crss (typical 18pF)
开关速度快	Fast switching
100%经过雪崩测试	100% avalanche tested
高抗 dv/dt 能力	Improved dv/dt capability
RoHS 产品	RoHS product

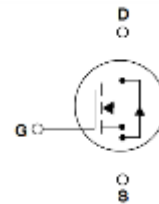
用途 APPLICATION

高频开关电源	High efficiency switch mode power supplies
电子镇流器	Electronic ballast
LED 电源	LED power supply

封装形式 Package



等效电路 Equivalent Circuit



绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 Parameter	符号 Symbol	数值 Value		单位 Unit
		FHP10N65B	FHF10N65B	
最高漏极-源极直流电压 Drain-Source Voltage	VDS	650		V
连续漏极电流* Drain Current -continuous *	ID (TC=25°C)	10*		A
	ID (TC=100°C)	6.2*		A
最大脉冲漏极电流 (注 1) Drain Current - pulse (note 1)	IDM	40*		A
最高栅源电压 Gate-Source Voltage	VGS	±30		V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	EAS	720		mJ
雪崩电流 (注 1) Avalanche Current (note 1)	IAR	15		A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	EAR	15.5		mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0		V/ns
耗散功率 Power Dissipation	PD (TC=25°C)	156	50	W
	-Derate above 25°C	1.43	0.48	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	TJ, TSTG	150, -55 to 150		°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	TL	300		°C

*漏极电流由最高结温限制 Drain current limited by maximum junction temperature

电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
漏-源击穿电压 Drain-Source Voltage	BVDSS	ID=250μA, VGS=0V	650	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	ΔBVDSS/ΔTJ	ID=250μA, referenced to 25°C	-	0.67	-	V/°C
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	IDSS	VDS=650V, VGS=0V, TC=25°C	-	-	1	μA
		VDS=520V, TC=125°C	-	-	100	μA
栅极体漏电流 Gate-body leakage current	IGSS (F/R)	VDS=0V, VGS =±30V	-	-	±100	μA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	VGS(th)	VDS = VGS, ID=250μA	3.0	-	5.0	V
静态导通电阻 Static Drain-Source On-Resistance	RDS(ON)	VGS =10V, ID=5A	-	0.75	0.9	Ω
正向跨导 Forward Transconductance	gfs	VDS = 40V, ID=5.0A (note 4)	-	5.7	-	S
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	Ciss	VDS=25V, VGS =0V, f=1.0MHz	-	1450	-	pF
输出电容 Output capacitance	Coss		-	150	-	
反向传输电容 Reverse transfer capacitance	Crss		-	10	-	
开关特性 Switching Characteristics						
延迟时间 Turn-On delay time	td(on)	VDS=325V, ID=10A, RG=25Ω (note 4, 5)	-	23	-	ns
上升时间 Turn-On rise time	tr		-	69	-	ns
延迟时间 Turn-Off delay time	td(off)		-	144	-	ns
下降时间 Turn-Off Fall time	tf		-	77	-	ns
栅极电荷总量 Total Gate Charge	Qg	VDS =520V , ID=10A , VGS =10V (note 4, 5)	-	30	-	nC
栅-源电荷 Gate-Source charge	Qgs		-	6.8	-	nC
栅-漏电荷 Gate-Drain charge	Qgd		-	10.3	-	nC
漏-源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings						
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current		IS	-	-	10	A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current		ISM	-	-	40	A
正向压降 Drain-Source Diode Forward Voltage	VSD	VGS=0V, IS=10A	-	-	1.4	V
反向恢复时间 Reverse recovery time	trr	VGS=0V, IS=10A, dIF/dt=100A/μs (note 4)	-	360	-	ns
反向恢复电荷 Reverse recovery charge	Qrr		-	3.3	-	μC

热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	FHP10N65B	FHF10N65B	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	Rth(j-c)	0.8	2.5	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	Rth(j-A)	62.5	62.5	°C/W

注释:

Notes:

- 1: 脉冲宽度由最高结温限制
- 2: L=10mH, I_{AS}=12A, V_{DD}=48V, R_G=25 Ω, 起始结温 T_J=25°C
- 3: I_{SD} ≤10A, di/dt ≤300A/μs, V_{DD} ≤B_VDSS, 起始结温 T_J=25°C
- 4: 脉冲测试: 脉冲宽度 ≤300μs, 占空比 ≤2%
- 5: 基本与工作温度无关

- 1: Pulse width limited by maximum junction temperature
- 2: L=10mH, I_D=12A, V_{DD}=48V, R_G=25 Ω, Start T_J=25°C.
- 3: I_{SD} ≤10A, di/dt ≤300A/μs, V_{DD} ≤B_VDSS, Starting T_J=25°C
- 4: Pulse Test: Pulse Width ≤300μs, Duty Cycle ≤2%
- 5: Essentially independent of operating temperatur

特性曲线

ELECTRICAL CHARACTERISTICS (curves)

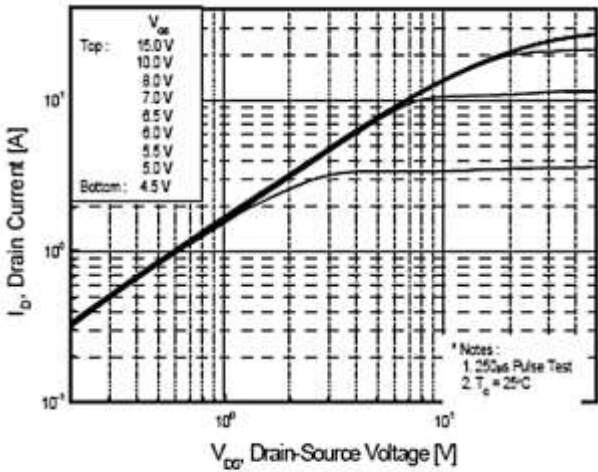


图 1 输出特性曲线, Tc=25°C

Fig1 Typical Output Characteristics, Tc=25°C

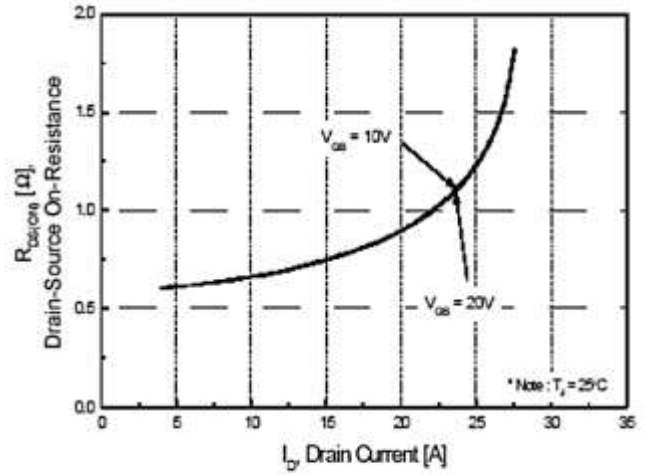


图 2 导通电阻与漏极电流和栅极电压曲线

Fig2 On-Resistance Vs.Drain Current and Gate Voltage

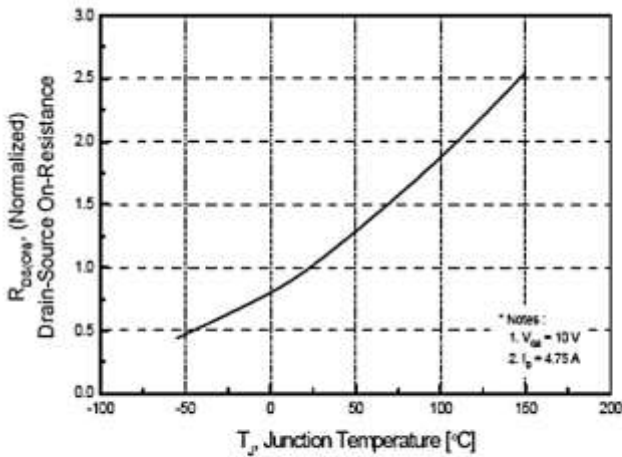


图 3 导通电阻与温度曲线

Fig3 Normalized On-Resistance Vs.Temperature

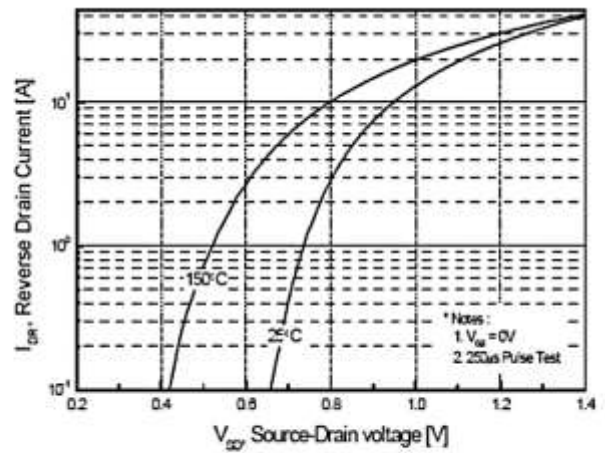


图 4 二极管正向电压曲线

Fig4 Typical Source-Drain Diode Forward Voltage

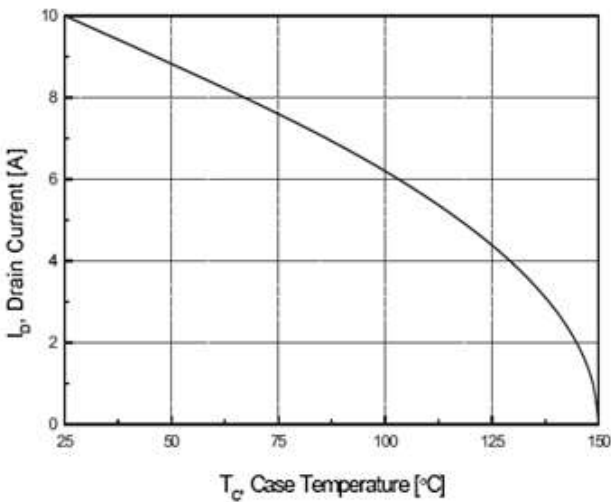


图 5 最大漏极电流与壳温曲线

Fig5 Maximum Drain Current Vs.Case Temperature

特性曲线

ELECTRICAL CHARACTERISTICS (curves)

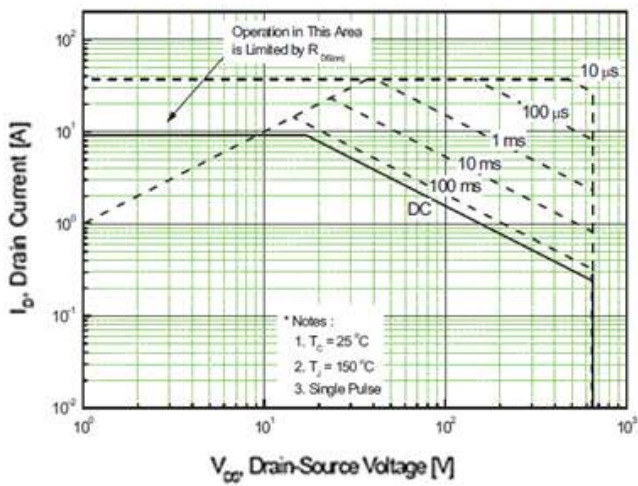


图 6-1 (TO-220)
最大安全工作区曲线
Fig6-1 Maximum Safe Operating Area

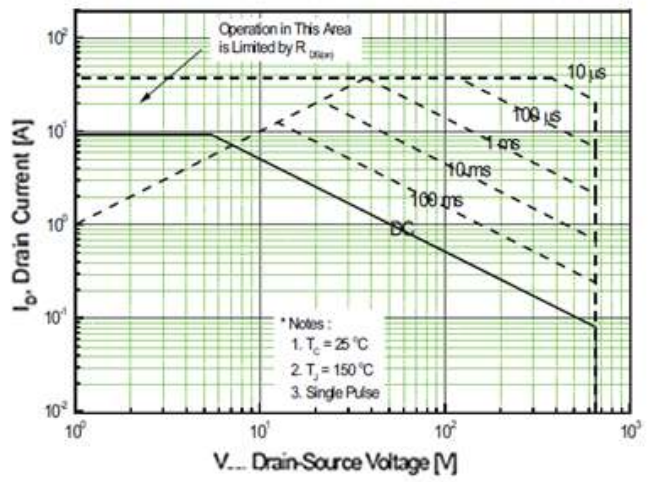
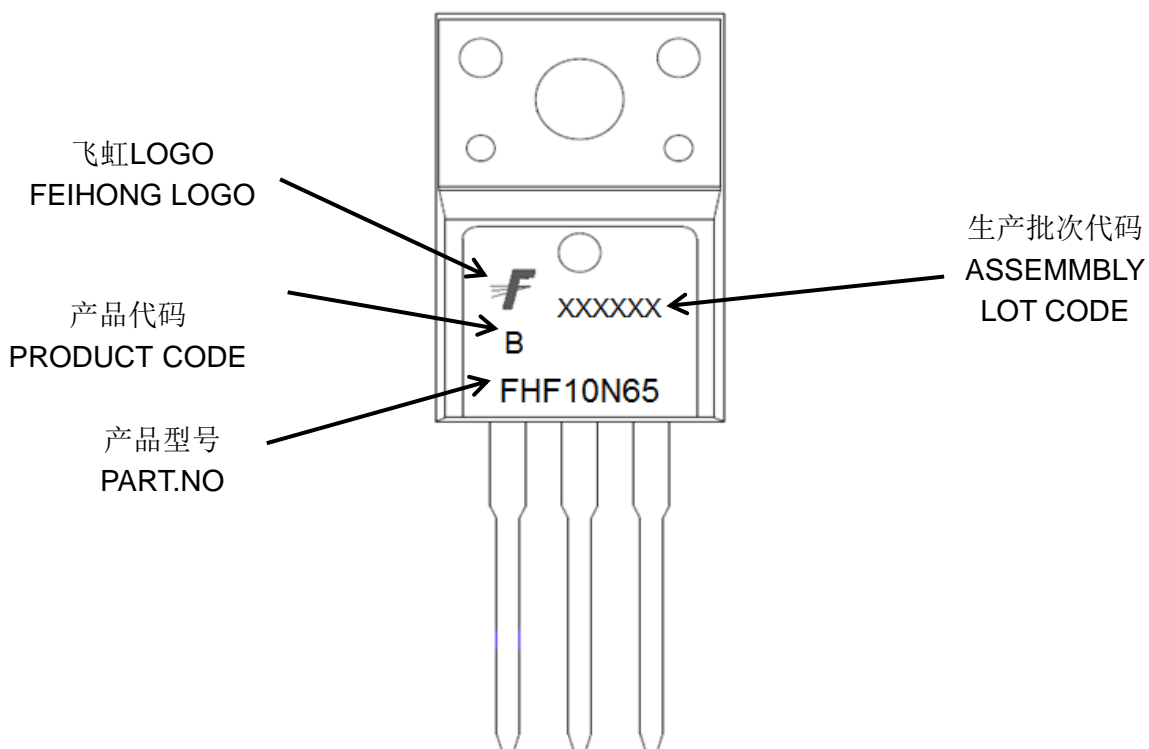
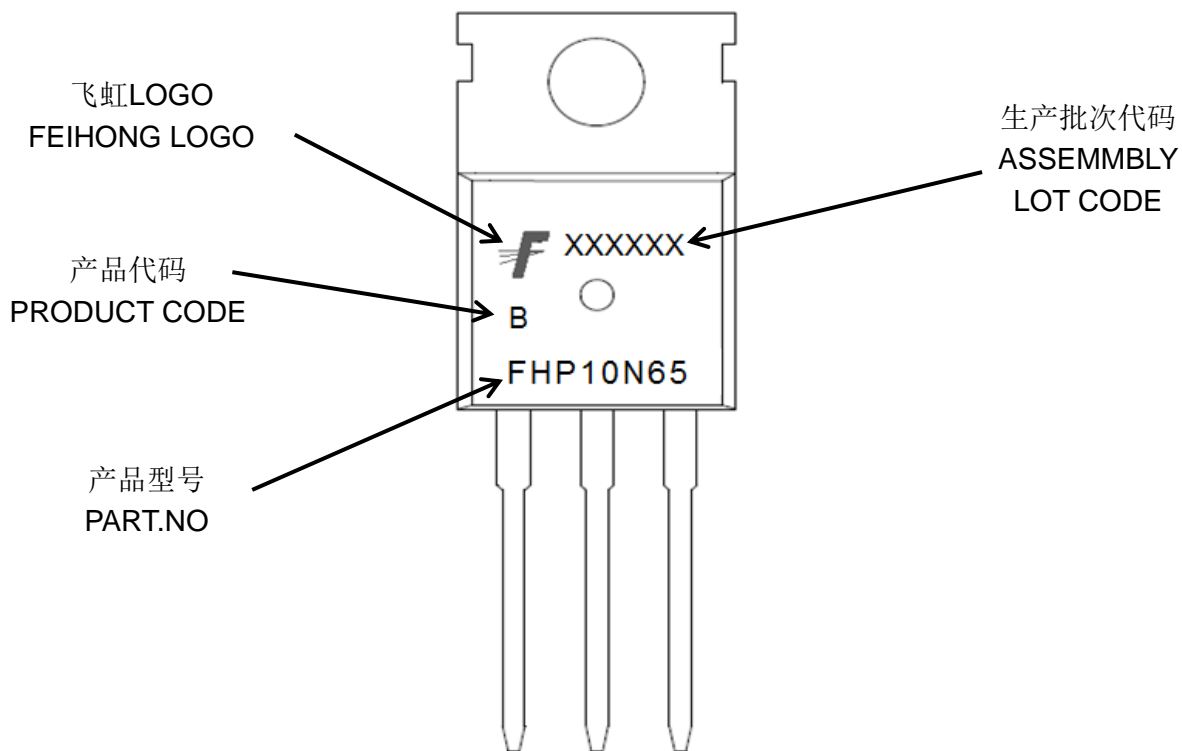


图 6-1 (TO-220F)
最大安全工作区曲线
Fig6 -2Maximum Safe Operating Area

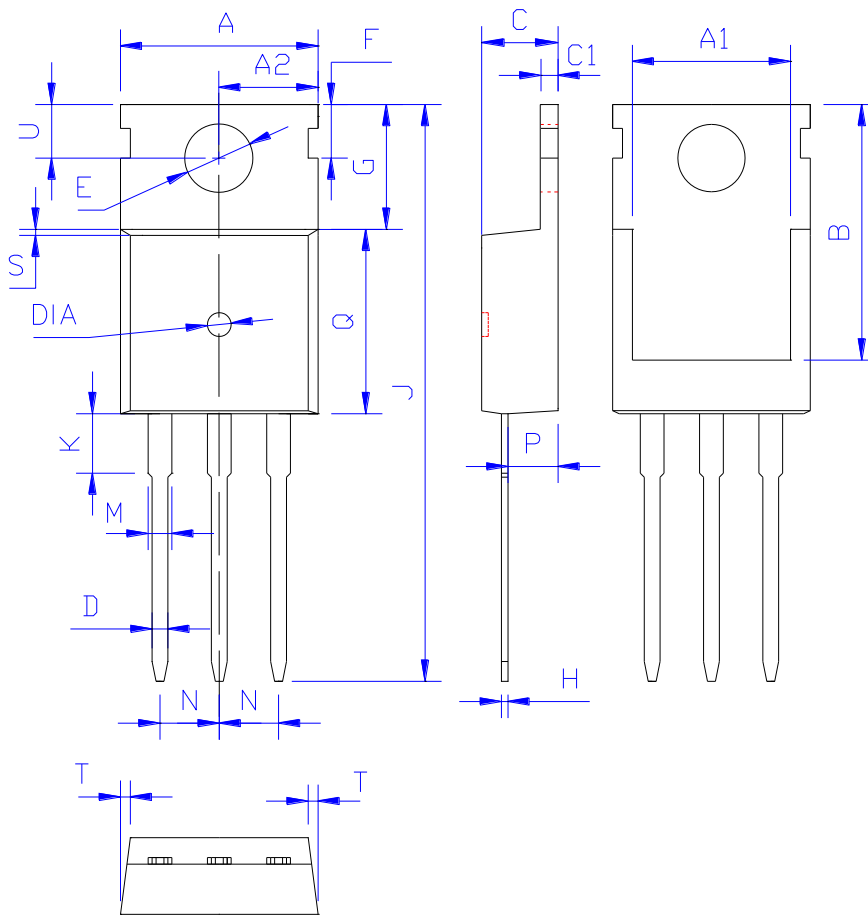
印记 Marking



外形尺寸:

Package Dimension:

TO-220



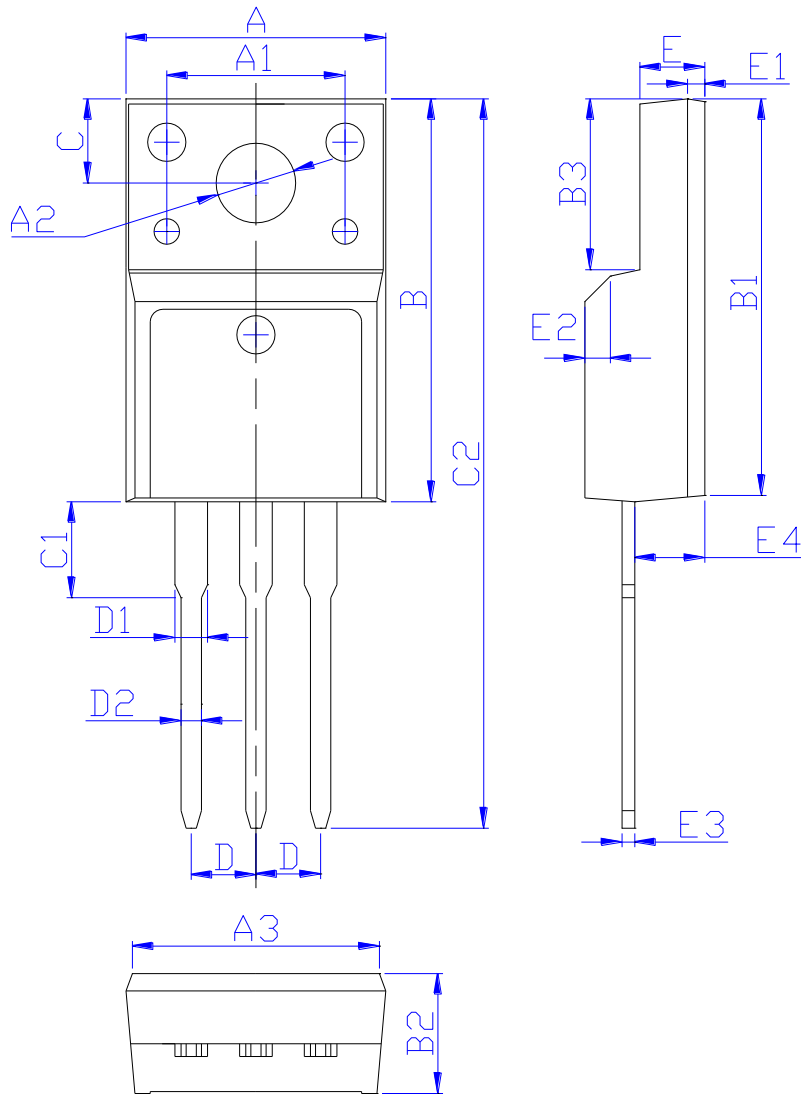
DIM	MILLIMETERS
A	10.00±0.30
A1	8.00±0.30
A2	5.00±0.30
B	13.20±0.40
C	4.50±0.20
C1	1.30±0.20
D	0.80±0.20
E	3.60±0.20
F	3.00±0.30
G	6.60±0.40
H	0.50±0.20
J	28.88±0.50
K	3.00±0.30
M	1.30±0.30
N	Typical 2.54
P	2.40±0.40
Q	9.20±0.40
S	0.25±0.15
T	0.25±0.15
U	2.80±0.30
DIA	宽 1.50±0.10 深 0.50 MAX

(Units: mm)

外形尺寸:

Package Dimension:

TO-220F



DIM	MILLIMETERS
A	10.16±0.30
A1	7.00±0.20
A2	3.12±0.20
A3	9.70±0.30
B	15.90±0.50
B1	15.60±0.50
B2	4.70±0.30
B3	6.70±0.30
C	3.30±0.25
C1	3.25±0.30
C2	28.70±0.50
D	Typical 2.54
D1	1.47 (MAX)
D2	0.80±0.20
E	2.55±0.25
E1	0.70±0.25
E2	1.0×45°
E3	0.50±0.20
E4	2.75±0.30

(Units : mm)